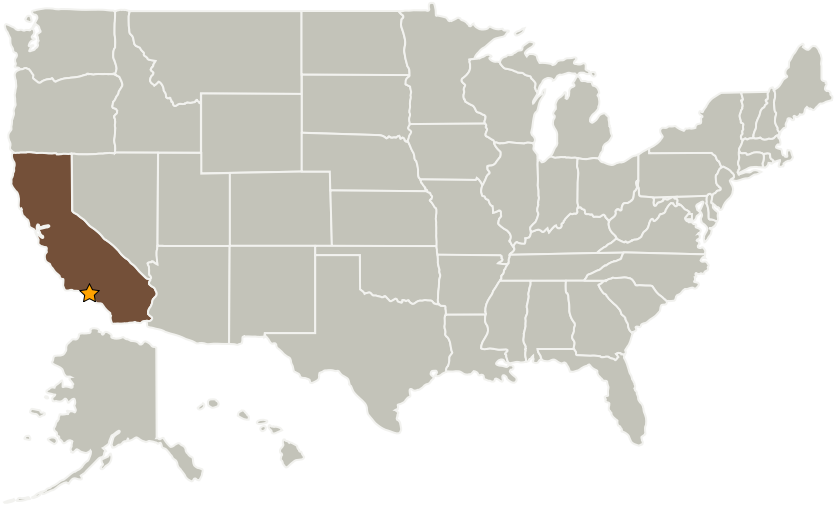
Radiation tolerant non volatile memory with Hard by Design Techniques, Phase II

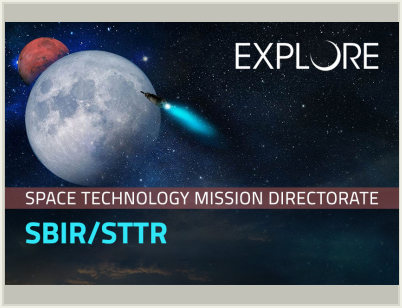
Completed Technology Project (2003 - 2005)

Primary U.S. Work Locations and Key Partners



Organizations Performing Work	Role	Type	Location
★Jet Propulsion Laboratory(JPL)	Lead Organization	NASA Center	Pasadena, California
NxGen Electronics, Inc.	Supporting Organization	Industry	San Diego, California

Primary U.S. Work Locations
California



Radiation tolerant non volatile memory with Hard by Design Techniques, Phase II

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Organizational Responsibility

Responsible Mission Directorate:

Space Technology Mission Directorate (STMD)

Lead Center / Facility:

Jet Propulsion Laboratory (JPL)

Responsible Program:

Small Business Innovation Research/Small Business Tech Transfer

Project Management

Program Director:

Jason L Kessler

Program Manager:

Carlos Torrez

Technology Areas

Primary:

- TX02 Flight Computing and Avionics
  └ TX02.1 Avionics Component Technologies
    └ TX02.1.4 High Performance Memories